

8A, 800V N-CHANNEL MOSFET

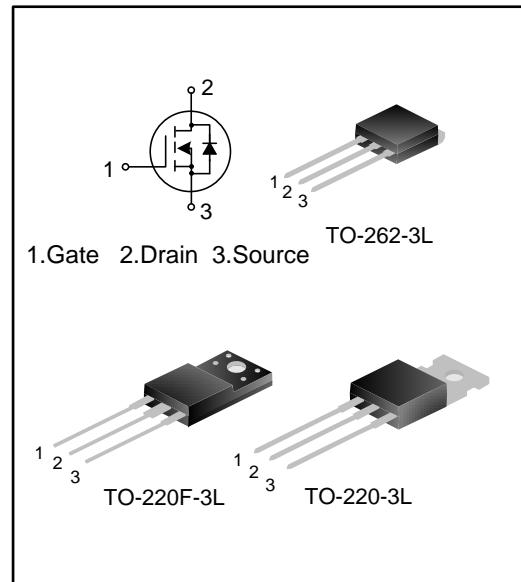
GENERAL DESCRIPTION

SVF8N80T/F/K is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ structure VDMOS technology. The improved planar stripe cell and the improved guard ring terminal have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are widely used in AC-DC power suppliers, DC-DC converters and H-bridge PWM motor drivers.

FEATURES

- 8A,800V, $R_{DS(on)(typ.)}=1.42\Omega$ @ $V_{GS}=10V$
- Low gate charge
- Low Crss
- Fast switching
- Improved dv/dt capability



ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVF8N80T	TO-220-3L	SVF8N80T	Pb free	Tube
SVF8N80F	TO-220F-3L	SVF8N80F	Pb free	Tube
SVF8N80K	TO-262-3L	SVF8N80K	Pb free	Tube



ABSOLUTE MAXIMUM RATINGS (T_c=25°C UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Ratings			Unit
		SVF8N80T	SVF8N80F	SVF8N80K	
Drain-Source Voltage	V _{DS}	800			V
Gate-Source Voltage	V _{GS}	±30			V
Drain Current	I _D	8.0			A
		5.1			
Drain Current Pulsed	I _{DM}	32.0			A
Power Dissipation(T _c =25°C) -Derate above 25°C	P _D	178	57	165	W
		1.42	0.46	1.32	W/°C
Single Pulsed Avalanche Energy (Note 1)	E _{AS}	534			mJ
Operation Junction Temperature Range	T _J	-55~+150			°C
Storage Temperature Range	T _{stg}	-55~+150			°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings			Unit
		SVF8N80T	SVF8N80F	SVF8N80K	
Thermal Resistance, Junction-to-Case	R _{θJC}	0.70	2.19	0.76	°C/W
Thermal Resistance, Junction-to-Ambient	R _{θJA}	62.5	62.5	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_c=25°C UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	B _{VDSS}	V _{GS} =0V, I _D =250μA	800	--	--	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =800V, V _{GS} =0V	--	--	1.0	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V	--	--	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D =250μA	2.0	--	4.0	V
Static Drain- Source On State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =4.0A	--	1.42	1.6	Ω
Input Capacitance	C _{iss}	V _{DS} =25V,V _{GS} =0V, f=1.0MHZ	--	1083	--	pF
Output Capacitance	C _{oss}		--	103	--	
Reverse Transfer Capacitance	C _{rss}		--	5.8	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} =400V, I _D =8.0A, R _G =25Ω	--	30.33	--	ns
Turn-on Rise Time	t _r		--	67.0	--	
Turn-off Delay Time	t _{d(off)}		--	58.0	--	
Turn-off Fall Time	t _f		--	38.33	--	
Total Gate Charge	Q _g	V _{DS} =640V,I _D =8.0A, V _{GS} =10V	--	24.62	--	nC
Gate-Source Charge	Q _{gs}		--	7.26	--	
Gate-Drain Charge	Q _{gd}		--	8.97	--	



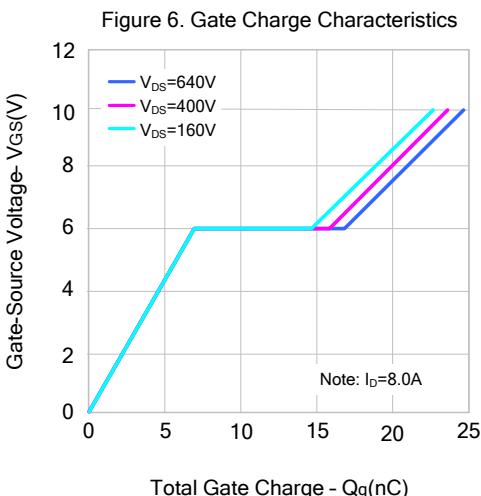
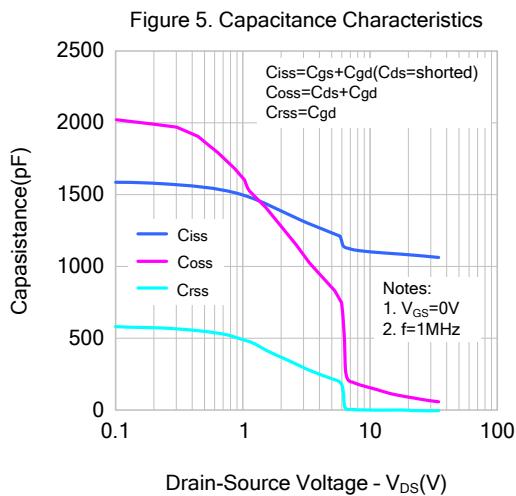
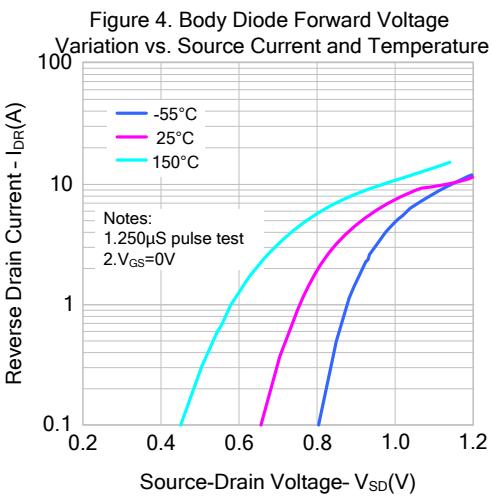
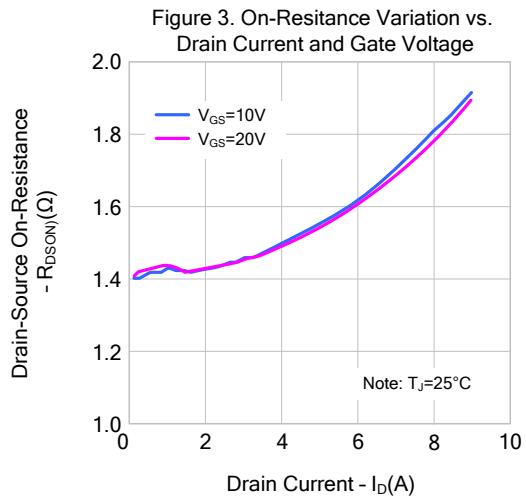
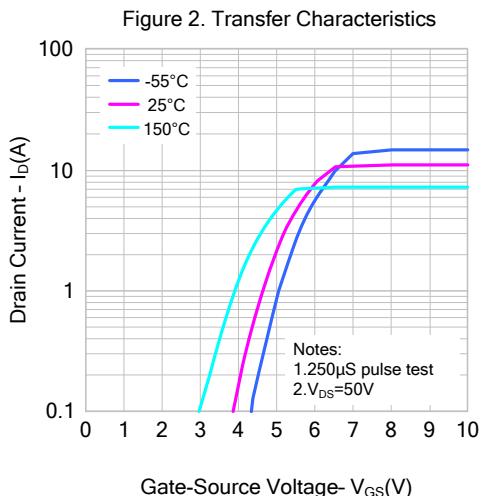
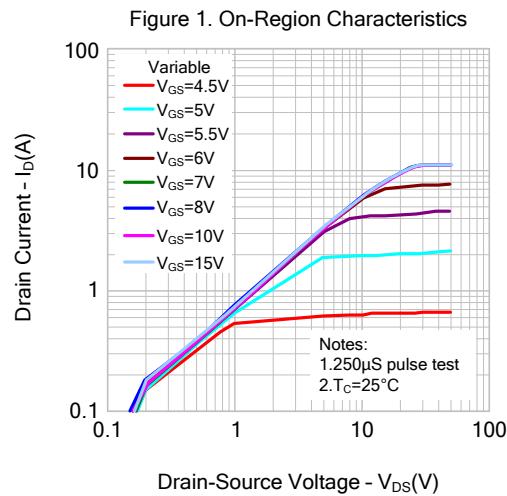
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I_S	Integral Reverse p-n Junction Diode in the MOSFET	--	--	8.0	A
Pulsed Source Current	I_{SM}		--	--	32.0	
Diode Forward Voltage	V_{SD}	$I_S=8.0A, V_{GS}=0V$	--	--	1.4	V
Reverse Recovery Time	T_{rr}	$I_S=8.0A, V_{GS}=0V,$ $dI_F/dt=100A/\mu S$	--	310	--	ns
Reverse Recovery Charge	Q_{rr}		--	0.53	--	μC

Notes:

1. $L=30mH, I_{AS}=5.50A, V_{DD}=135V, R_G=25\Omega$, starting $T_J=25^\circ C$;
2. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$;
3. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS





TYPICAL CHARACTERISTICS (CONTINUED)

Figure 7. Breakdown Voltage Variation vs. Temperature

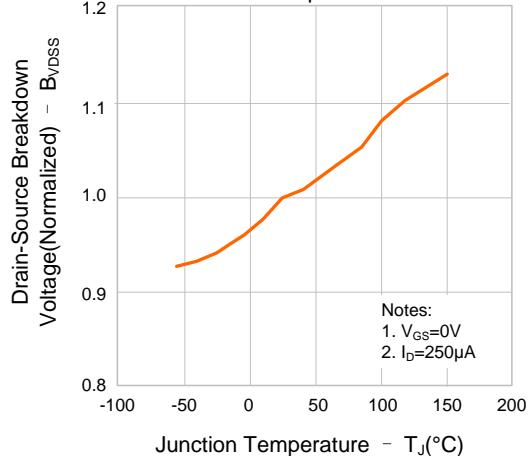


Figure 8. On-resistance Variation vs. Temperature

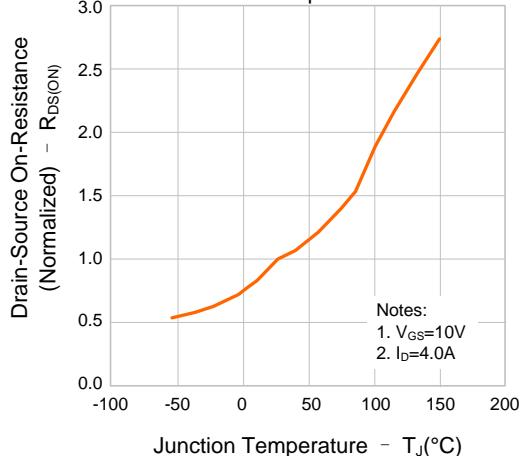


Figure 9-1. Max. Safe Operating Area(SVF8N80T)

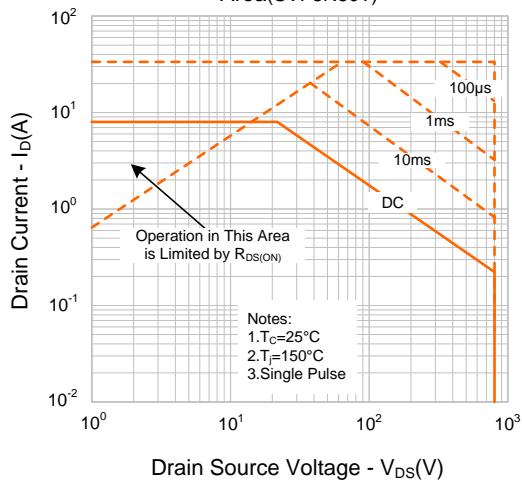


Figure 9-2. Max. Safe Operating Area(SVF8N80F)

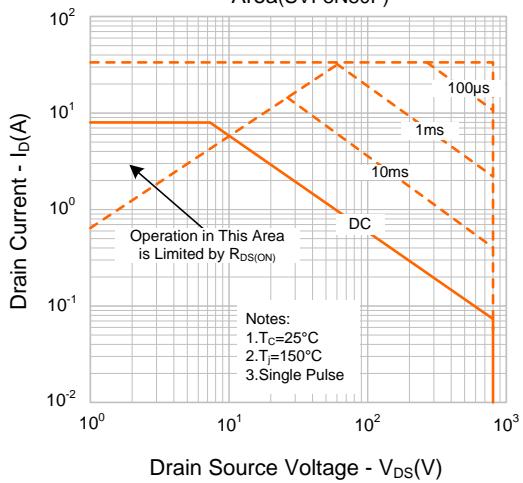


Figure 9-3. Max. Safe Operating Area(SVF8N80K)

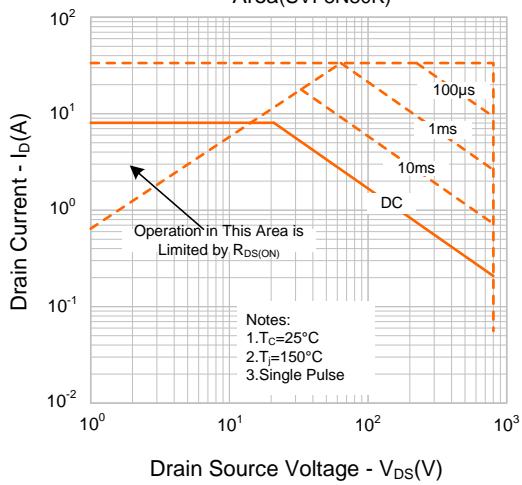
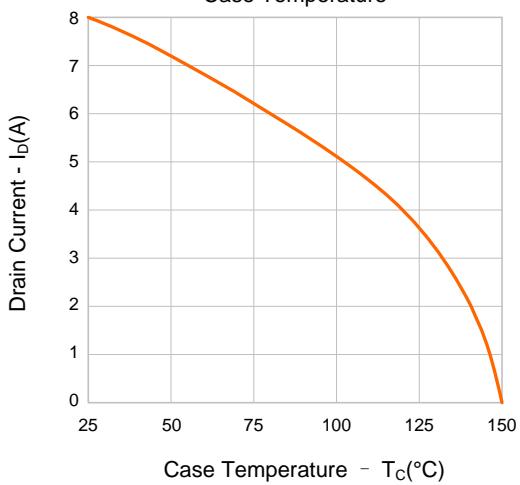


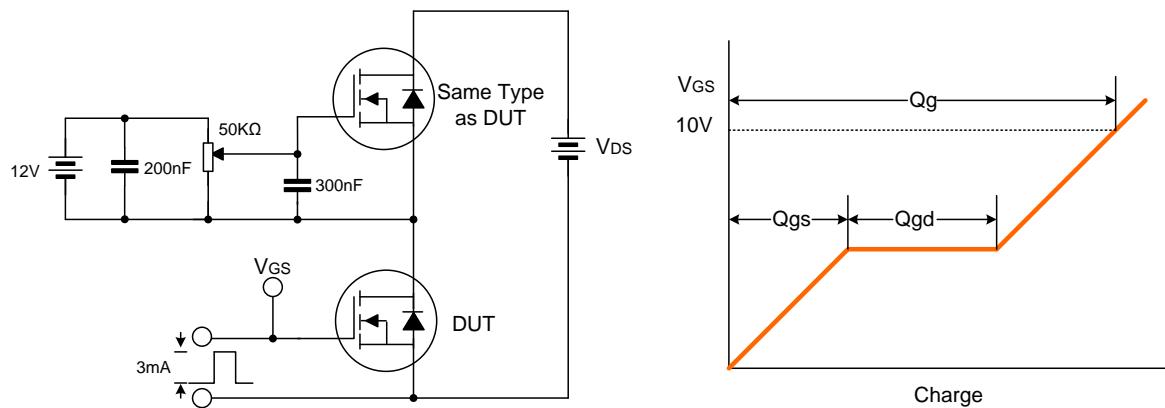
Figure 10. Maximum Drain Current vs. Case Temperature



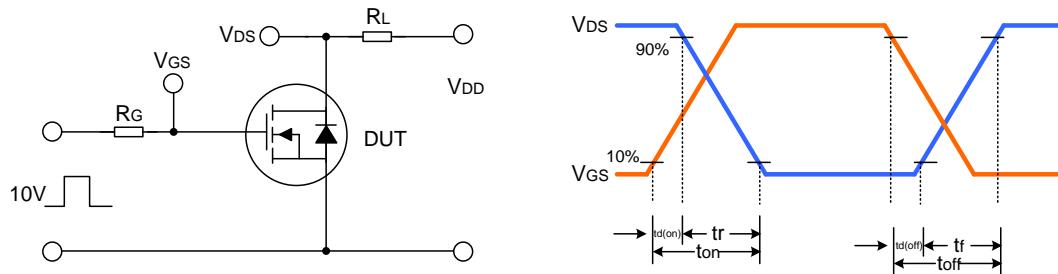


TYPICAL TEST CIRCUIT

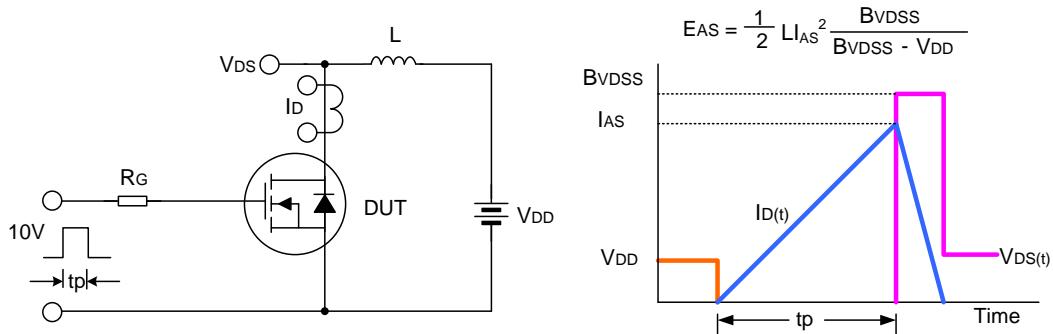
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform

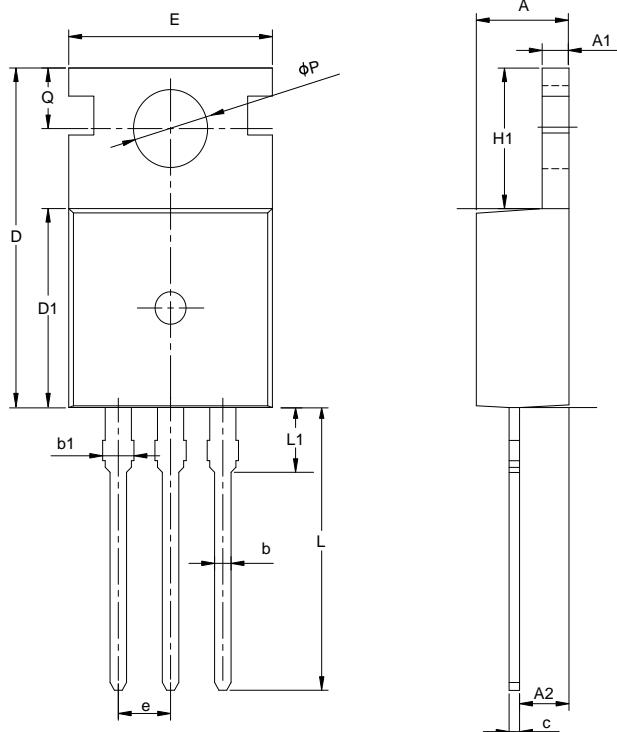




PACKAGE OUTLINE

TO-220-3L

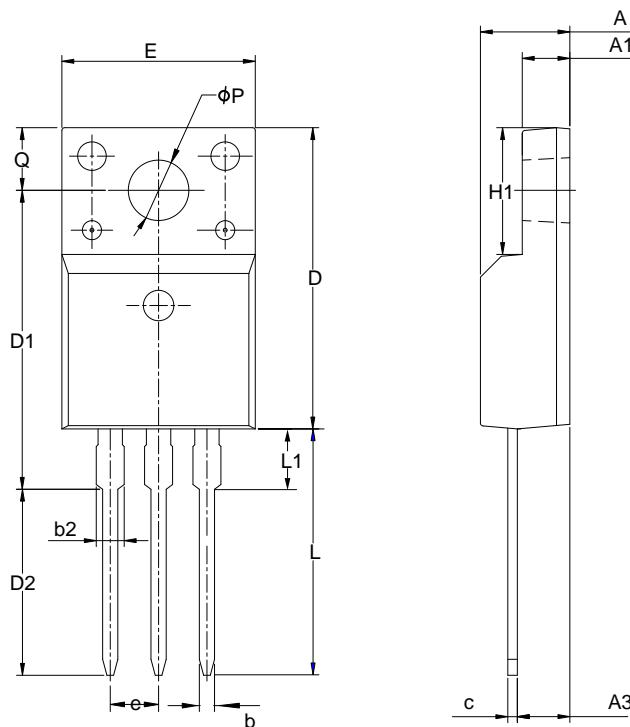
UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	1.00	1.30	1.50
A2	1.80	2.40	2.80
b	0.60	0.80	1.00
b1	1.00	—	1.60
c	0.30	—	0.70
D	15.10	15.70	16.10
D1	8.10	9.20	10.00
E	9.60	9.90	10.40
e	2.54BSC		
H1	6.10	6.50	7.00
L	12.60	13.08	13.60
L1	—	—	3.95
φP	3.40	3.70	3.90
Q	2.60	—	3.20

TO-220F-3L

UNIT: mm



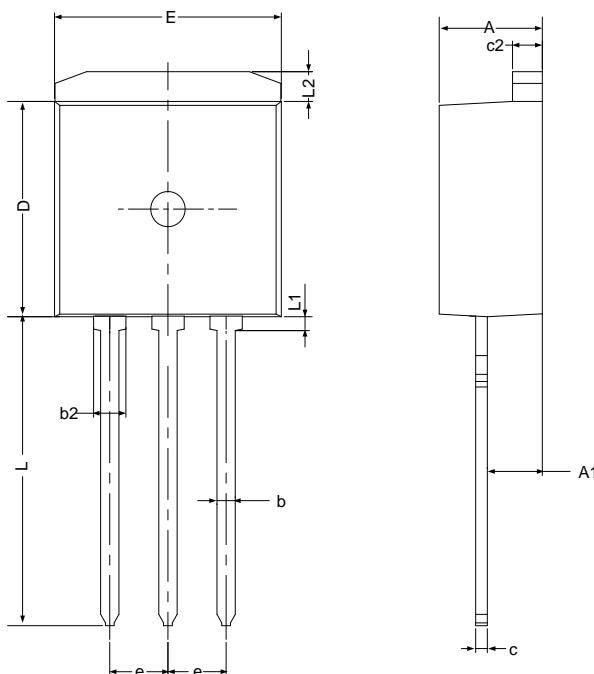
SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.70	0.80	0.90
b2	—	—	1.47
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	15.30	15.75	16.30
D2	9.30	9.80	10.30
E	9.73	10.16	10.36
e	2.54BSC		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	3.50
φP	3.00	3.18	3.40
Q	3.05	3.30	3.55



PACKAGE OUTLINE(CONTINUED)

TO-262-3L

UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	2.20	—	2.92
b	0.71	0.80	0.90
b2	1.20	—	1.50
c	0.34	—	0.65
c2	1.22	1.30	1.35
D	8.38	—	9.30
E	9.80	10.16	10.54
e	2.54 BSC		
L	12.80	—	14.10
L1	—	—	0.75
L2	1.12	—	1.42

Important notice :

- The instructions are subject to change without notice! Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current.
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- Product promotion is endless, our company will wholeheartedly provide customers with better products!
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Rev.: **2.1**

Revision History:

1. Deleted NOMENCLATURE
 2. Modify Important notice
 3. Modify the Hazardous Substance Control of SVF8N80K
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Rev.: **2.0**

Revision History:

1. Modify the package outline of TO-262-3L
 2. Modify the ordering information
-

Rev.: **1.9**

Revision History:

1. Modify the package information of TO-220F-3L
-

Rev.: **1.8**

Revision History:

1. Modify the package information of TO-220F-3L
-

Rev.: **1.7**

Revision History:

1. Add information for TO-262-3L package
-

Rev.: **1.6**

Revision History:

1. Modify the ordering information
-

Rev.: **1.5**

Revision History:

1. Modify the thermal characteristics
-

Rev.: **1.4**

Revision History:

1. Modify the ordering information
-

Rev.: **1.3**

Revision History:

1. Change the schematic diagram of MOS
-

Rev.: **1.2**

Revision History:

1. Modify the max. value of Static Drain- Source On State Resistance
-

Rev.: **1.1**

Revision History:

1. Modify "PACKAGE OUTLINE"
-

Rev.: **1.0**

Revision History:



Silan
Microelectronics

Document Type: _Datasheet

1. Initial release
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